

Zener Diodes



SMA (DO-214AC)

FEATURES

- High reliability
- Voltage range 10 V to 270 V
- Fits onto 5 mm SMD footpads
- Wave and reflow solderable
- AEC-Q101 qualified available
- Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
- Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Voltage stabilization

| PRIMARY CHARACTERISTICS | | |
|------------------------------|-----------------|------|
| PARAMETER | VALUE | UNIT |
| V _Z range nom. | 10 to 270 | V |
| Test current I _{ZT} | 2 to 50 | mA |
| V _{BR} | 9.4 to 251 | V |
| V _{WM} | 8.2 to 220 | V |
| P _{PPM} | 300 | W |
| T _J max. | 150 | °C |
| V _Z specification | Pulse current | |
| Circuit configuration | Single | |
| Polarity | Uni-directional | |

| ORDERING INFORMATION | | | |
|----------------------|------------------|----------------------|------------------------|
| DEVICE NAME | ORDERING CODE | TAPED UNITS PER REEL | MINIMUM ORDER QUANTITY |
| BZG03C-M-series | BZG03Cxxx-M3-08 | 1500 (7" reel) | 6000/box |
| BZG03C-M-series | BZG03Cxxx-M3-18 | 6000 (13" reel) | 6000/box |
| BZG03C-M-series | BZG03Cxxx-HM3-08 | 1500 (7" reel) | 6000/box |
| BZG03C-M-series | BZG03Cxxx-HM3-18 | 6000 (13" reel) | 6000/box |

| PACKAGE | | | | |
|----------------|--------|--------------------------------------|--------------------------------------|--------------------------|
| PACKAGE NAME | WEIGHT | MOLDING COMPOUND FLAMMABILITY RATING | MOISTURE SENSITIVITY LEVEL | SOLDERING CONDITIONS |
| SMA (DO-214AC) | 73 mg | UL 94 V-0 | MSL level 1 (according J-STD-020) | 260 °C/10 s at terminals |

| ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified) | | | | |
|---|---|-------------------|-------------|------|
| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
| Power dissipation | R _{thJA} < 25 K/W, T _{amb} = 100 °C | P _{tot} | 3000 | mW |
| | R _{thJA} < 100 K/W, T _{amb} = 50 °C | P _{tot} | 1250 | mW |
| Non repetitive peak surge power dissipation | t _p = 100 μs sq.pulse, T _j = 25 °C prior to surge | P _{ZSM} | 600 | W |
| Junction to lead | | R _{thJL} | 25 | K/W |
| Junction to ambient air | Mounted on epoxy-glass hard tissue, fig. 1a | R _{thJA} | 150 | K/W |
| | Mounted on epoxy-glass hard tissue, fig. 1b | R _{thJA} | 125 | K/W |
| | Mounted on Al-oxide-ceramic (Al ₂ O ₃), fig. 1b | R _{thJA} | 100 | K/W |
| Junction temperature | | T _j | 150 | °C |
| Storage temperature range | | T _{stg} | -65 to +150 | °C |
| Forward voltage (max.) | I _F = 0.5 A | V _F | 1.2 | V |



| ELECTRICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) | | | | | | | | | | |
|--|---------------------|------|------|--------------|-------------------------|-----|--------------------|------|--|------|
| PART NUMBER | ZENER VOLTAGE RANGE | | | TEST CURRENT | REVERSE LEAKAGE CURRENT | | DYNAMIC RESISTANCE | | TEMPERATURE COEFFICIENT OF ZENER VOLTAGE | |
| | V_Z at I_{ZT1} | | | I_{ZT1} | I_R at V_R | | Z_Z at I_{ZT1} | | TK_{VZ} at I_{ZT1} | |
| | V | | | mA | μA | V | Ω | | %K | |
| | MIN. | NOM. | MAX. | | MAX. | | TYP. | MAX. | MIN. | MAX. |
| BZG03C10-M | 9.4 | 10 | 10.6 | 50 | 10 | 7.5 | 2 | 4 | 0.05 | 0.09 |
| BZG03C11-M | 10.4 | 11 | 11.6 | 50 | 4 | 8.2 | 4 | 7 | 0.05 | 0.1 |
| BZG03C12-M | 11.4 | 12 | 12.7 | 50 | 3 | 9.1 | 4 | 7 | 0.05 | 0.1 |
| BZG03C13-M | 12.4 | 13 | 14.1 | 50 | 2 | 10 | 5 | 10 | 0.05 | 0.1 |
| BZG03C15-M | 13.8 | 15 | 15.6 | 50 | 1 | 11 | 5 | 10 | 0.05 | 0.1 |
| BZG03C16-M | 15.3 | 16 | 17.1 | 25 | 1 | 12 | 6 | 15 | 0.06 | 0.11 |
| BZG03C18-M | 16.8 | 18 | 19.1 | 25 | 1 | 13 | 6 | 15 | 0.06 | 0.11 |
| BZG03C20-M | 18.8 | 20 | 21.2 | 25 | 1 | 15 | 6 | 15 | 0.06 | 0.11 |
| BZG03C22-M | 20.8 | 22 | 23.3 | 25 | 1 | 16 | 6 | 15 | 0.06 | 0.11 |
| BZG03C24-M | 22.8 | 24 | 25.6 | 25 | 1 | 18 | 7 | 15 | 0.06 | 0.11 |
| BZG03C27-M | 25.1 | 27 | 28.9 | 25 | 1 | 20 | 7 | 15 | 0.06 | 0.11 |
| BZG03C30-M | 28 | 30 | 32 | 25 | 1 | 22 | 8 | 15 | 0.06 | 0.11 |
| BZG03C33-M | 31 | 33 | 35 | 25 | 1 | 24 | 8 | 15 | 0.06 | 0.11 |
| BZG03C36-M | 34 | 36 | 38 | 10 | 1 | 27 | 21 | 40 | 0.06 | 0.11 |
| BZG03C39-M | 37 | 39 | 41 | 10 | 1 | 30 | 21 | 40 | 0.06 | 0.11 |
| BZG03C43-M | 40 | 43 | 46 | 10 | 1 | 33 | 24 | 45 | 0.07 | 0.12 |
| BZG03C47-M | 44 | 47 | 50 | 10 | 1 | 36 | 24 | 45 | 0.07 | 0.12 |
| BZG03C51-M | 48 | 51 | 54 | 10 | 1 | 39 | 25 | 60 | 0.07 | 0.12 |
| BZG03C56-M | 52 | 56 | 60 | 10 | 1 | 43 | 25 | 60 | 0.07 | 0.12 |
| BZG03C62-M | 58 | 62 | 66 | 10 | 1 | 47 | 25 | 80 | 0.08 | 0.13 |
| BZG03C68-M | 64 | 68 | 72 | 10 | 1 | 51 | 25 | 80 | 0.08 | 0.13 |
| BZG03C75-M | 70 | 75 | 79 | 10 | 1 | 56 | 30 | 100 | 0.08 | 0.13 |
| BZG03C82-M | 77 | 82 | 87 | 10 | 1 | 62 | 30 | 100 | 0.08 | 0.13 |
| BZG03C91-M | 85 | 91 | 96 | 5 | 1 | 68 | 60 | 200 | 0.09 | 0.13 |
| BZG03C100-M | 94 | 100 | 106 | 5 | 1 | 75 | 60 | 200 | 0.09 | 0.13 |
| BZG03C110-M | 104 | 110 | 116 | 5 | 1 | 82 | 80 | 250 | 0.09 | 0.13 |
| BZG03C120-M | 114 | 120 | 127 | 5 | 1 | 91 | 80 | 250 | 0.09 | 0.13 |
| BZG03C130-M | 124 | 130 | 141 | 5 | 1 | 100 | 110 | 300 | 0.09 | 0.13 |
| BZG03C150-M | 138 | 150 | 156 | 5 | 1 | 110 | 130 | 300 | 0.09 | 0.13 |
| BZG03C160-M | 158 | 160 | 171 | 5 | 1 | 120 | 150 | 350 | 0.09 | 0.13 |
| BZG03C180-M | 168 | 180 | 191 | 5 | 1 | 130 | 180 | 400 | 0.09 | 0.13 |
| BZG03C200-M | 188 | 200 | 212 | 5 | 1 | 150 | 200 | 500 | 0.09 | 0.13 |
| BZG03C220-M | 208 | 220 | 233 | 2 | 1 | 160 | 350 | 750 | 0.09 | 0.13 |
| BZG03C240-M | 228 | 240 | 256 | 2 | 1 | 180 | 400 | 850 | 0.09 | 0.13 |
| BZG03C270-M | 251 | 270 | 289 | 2 | 1 | 200 | 450 | 1000 | 0.09 | 0.13 |

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)



Fig. 1 - Boards for R_{thJA} Definition (Copper Overlay 35 μ)



Fig. 3 - Forward Current vs. Forward Voltage

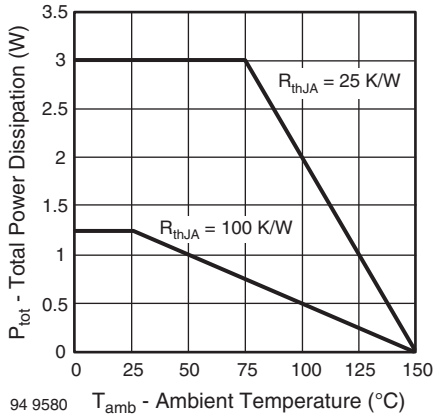


Fig. 2 - Total Power Dissipation vs. Ambient Temperature

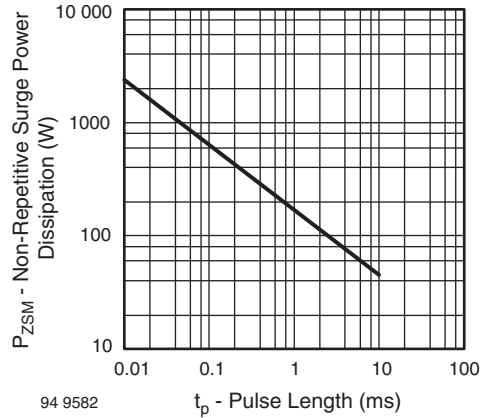


Fig. 4 - Non Repetitive Surge Power Dissipation vs. Pulse Length

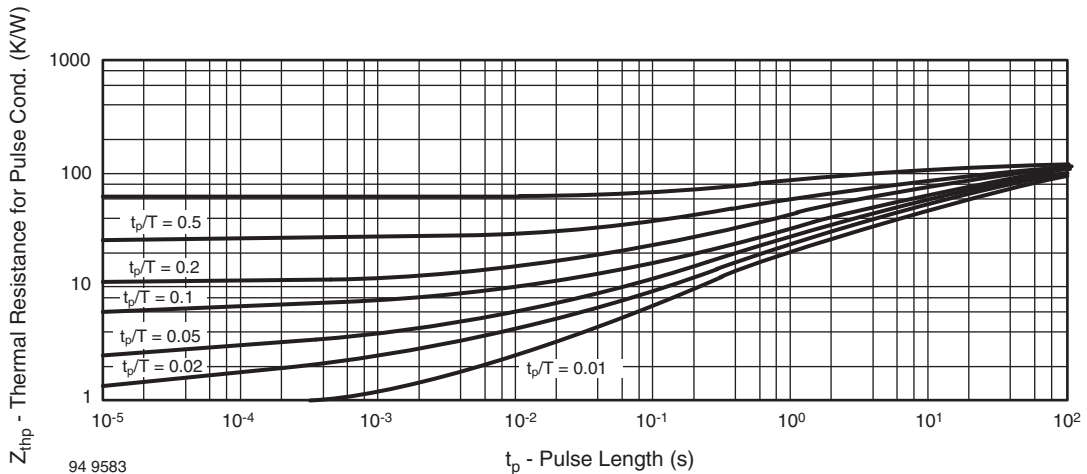
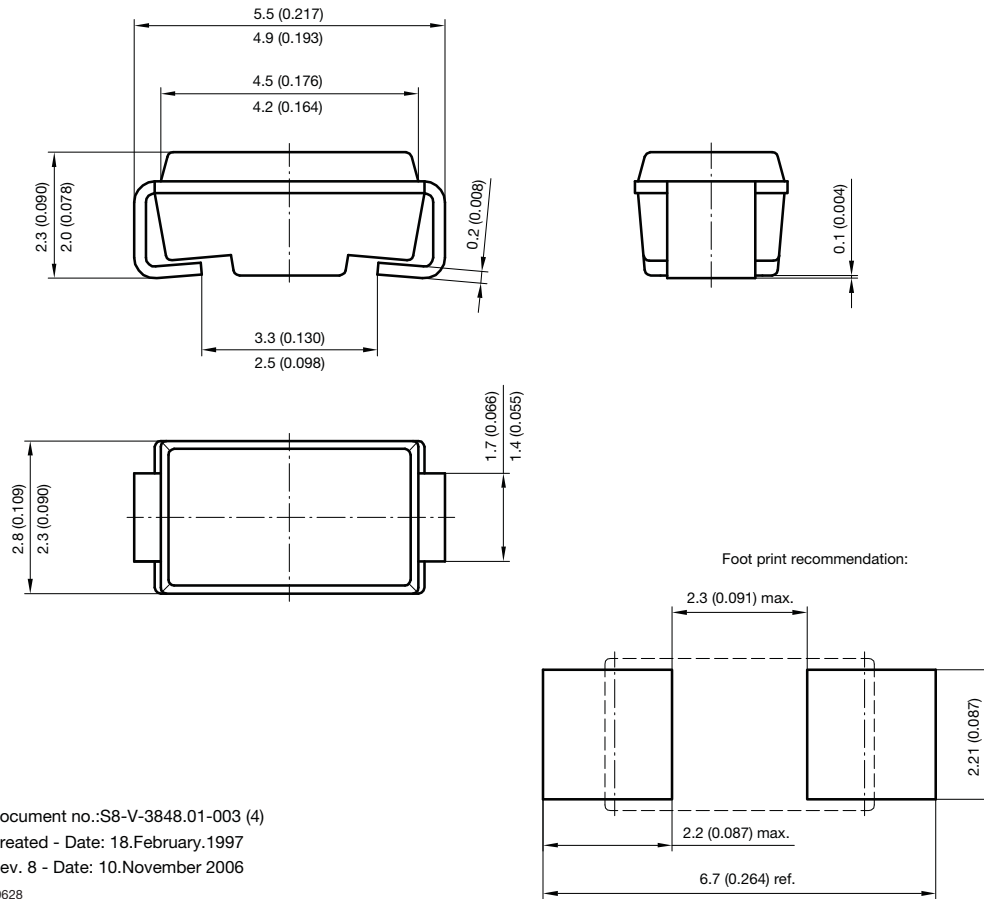


Fig. 5 - Thermal Response



PACKAGE DIMENSIONS in millimeters (inches): **SMA (DO-214AC)**



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- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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